

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: **Pancham, et al.**

Serial No.: 10/680,325

Examiner: **Tadesse, Yewebdar, T.**

Confirmation No.: 5447

**Title: APPARATUS TO IMPROVE  
WAFER TEMPERATURE  
UNIFORMITY FOR FACE-UP WET  
PROCESSING**

§ Case: AMAT/8024/CMP/ECP/RKK

Filed: October 6, 2003

§ Group Art Unit: 1734

**Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450**

Dear Sir:

**RESPONSE TO OFFICE ACTION DATED MARCH 1, 2006**

In response to the Office Action dated March 1, 2006, having a shortened statutory period for response set to expire on June 1, 2006, please enter this response and reconsider the claims pending in the application for reasons discussed below. Applicants believe that a one-month extension of \$120.00 is due in connection with this response. This fee has been paid with the submission of this paper using the Patent Electronic Business Center. The Commissioner is authorized to charge any additional fees due for this Response, including additional extension of time or other fees, to Deposit Account No. 20-0782.